



ERROR AND CORRECTION SIMULATION OF CEPC BOOSTER AND DAMPING RING

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Error Set

Parameters	Dipole	Quadrupole	Sextupole
Transverse shift X/Y (μm)	100	100	100
Longitudinal shift Z (μm)	100	150	100
Tilt about X/Y (mrad)	0.2	0.2	0.2
Tilt about Z (mrad)	0.1	0.2	0.1
Nominal field	1×10^{-3}	2×10^{-4}	3×10^{-4}

Parameters	BPM (10 Hz)
Accuracy (m)	1×10^{-7}
Tilt (mrad)	10
Gain	5%
Offset after beam based alignment (BBA) (mm)	30×10^{-3}

Correction Process

Orbit Correction + Horizontal dispersion

- Response Matrix
- 2-level iteration:
 - 1st Loop: 20%~100% Corrector
 - 2nd Loop: 30%~80% SVD
- Dispersion correction
- Energy adjustment by corrector

Optics correction

- RM + LOCO
- Based on 30GeV simulation
- All quadrupole independent
- Dispersion correction included

Dispersion correction included

- Coupling and vertical dispersion correction
- Skew quadrupole magnets are arranged in both the dispersion free section and the arc section.

Booster Design update

To reduce emittance, costs and sensitivity

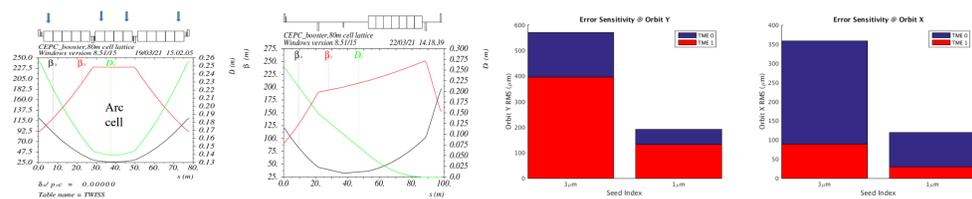
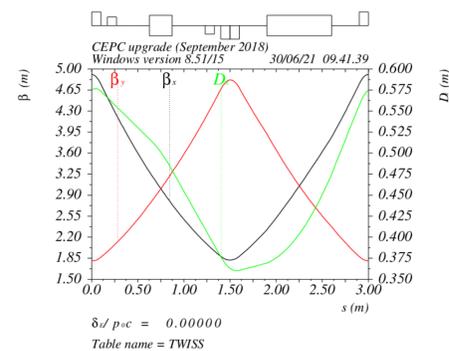
- TME like structure (cell length=78m)
- Interleave sextupole scheme
- Overall idea: uniform distribution for the Q
- Combined magnet (B+S) scheme possible
- Phase advance/cell: 100° (H) / 28° (V)
- [Emittance@120GeV=1.26nm](#)

Damping RING Design

Phase/cell: $60^\circ / 60^\circ$

Interleave sextupole scheme

2 sex. families

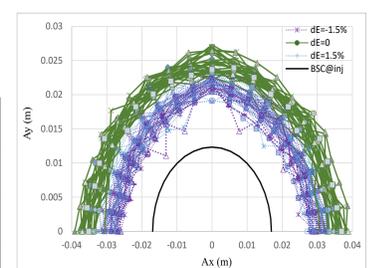


Booster Beam parameter with correction

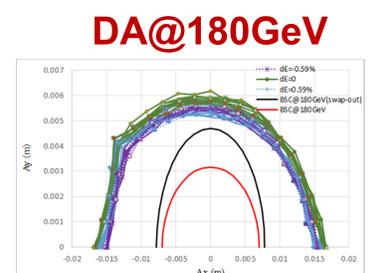
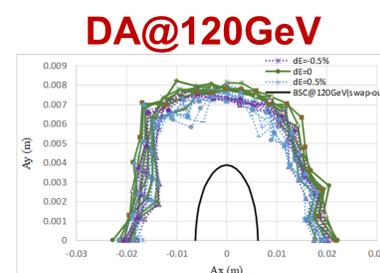
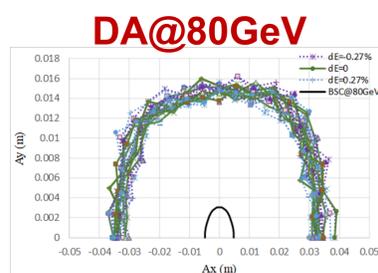
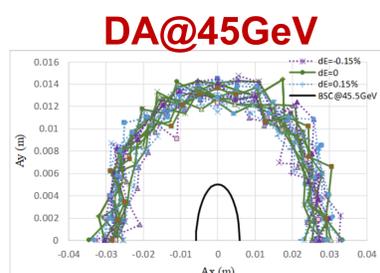
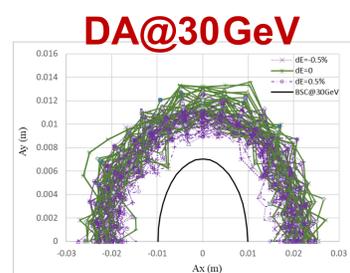
RMS@30GeV	X	Y
Orbit (mm)	0.080	0.080
Beta Beating(%)	0.8	0.38
Δ Dispersion(mm)	2.7	3.5

Damping Ring parameter with correction

RMS@30GeV	X	Y
Orbit (mm)	0.58	0.56
Beta Beating(%)	1.1	2.0
Δ Dispersion(mm)	6.4	2.4



- $BSC_{x,y} = 5\sigma_{inj,x,y} + 5mm$
- Energy acceptance: $8.3\delta_{inj} = 1.5\%$



Summary

The TME structure (TDR) has combined magnets to reduce mounts, minimize beam emittance, optimize error sensitivity, simulate error effects and corrections, and determine hardware system requirements, with a clear simulation process showing that linear parameters and DA meet the requirements. Further studies will prioritize actual commissioning requirements..